

BOM OF Plazzo Remote

	BUYER : CELADON	BUYER MODEL:RF Remote(Plazzo)	DATE: 2007.2.23			
No	DESCRIPTION	SPECIFICATION	Q'TY	Ref No.	Vendor	Remarks
1	PCB CHIP MOUNT					
2	Transmitter MAIN P.C.B	37X 184 X 1.6T(XPC, D/S), SBDB6100-10012	1		FINE	
3	IC, MICOM	S3F80J9-28, SOP28, OTP	1	IC1	Samsung	
4	IC, eeprom	24AA02T-1/SNG, SOP8	1	IC2	Microchip	
5	Programmed	OBJ & ID	1			
6	LED	3ø, Green	1	D1		
7	Chip Diode	KDR729	1	D3	KEC	
8	Chip Diode	KDR729	1	D2,3	KEC	
9	Chip Transistor	2SC4226(R25)	1	Q6	NEC	
10	Chip Transistor	KRC4075	1	Q4	KEC	
11	Chip Transistor	KRA306	1	Q5	KEC	
12	CHIP CERMIC CAP. (#1608)	4pF/50V, COG,±0.25pF	1	C2	Samsung	
13	CHIP CERMIC CAP. (#1608)	18pF/50V, COG,±0.25pF	1	C11	Samsung	
14	CHIP CERMIC CAP. (#1608)	15pF/50V, COG,J	1	C12	Samsung	
15	CHIP CERMIC CAP. (#1608)	10nF/50V,Z5U, Z	2	C14,18	Samsung	
16	CHIP CERMIC CAP. (#1608)	100pF/50V,X7R, J	1	C15	Samsung	
17	CHIP CERMIC CAP. (#1608)	27pF/50V, COG, J	1	C20	Samsung	
18	CHIP CERMIC CAP. (#1608)	47pF/50V, COG,J	1	C8	Samsung	
19	CHIP CERMIC CAP. (#2012)	100nF/50V, Z5U, Z	2	C21,22	Samsung	
20	ELECT Capacitor	220uF/10V	1	C23	Samsung	
21	CHIP INDUCTOR (#1608)	1uH, J	2	L7,8	Samsung	
22	CHIP INDUCTOR (#1608)	4.7nH, J	1	L5	Samsung	
23	CHIP INDUCTOR (#1608)	47nH, J	1	L1	Samsung	
24	CHIP INDUCTOR (#1608)	15nH, J	1	C10	Samsung	
25	CHIP RESISTOR (#1608)	0ohm, J	3	JP3,4,R10	Samsung	
26	CHIP RESISTOR (#1608)	560R, J	1	R8	Samsung	
27	CHIP RESISTOR (#1608)	10K, J	1	R12	Samsung	
28	CHIP RESISTOR (#2012)	10K, J	1	R21	Samsung	
29	CHIP RESISTOR (#1608)	39K, J	1	R13	Samsung	
30	CHIP RESISTOR (#2012)	4.7K, J	2	R23,24	Samsung	
31	Ceramic Resonator	4Mhz, IFR4000T00B02,DIP	1	X1	CQ	
32	Saw Resonator	433.92MHz,T039,±50KHz	1	Y2	CQ	
33	ALKALINE BATTERY	AAA TYPE	2	BAT1		
34	Bat. SPRING (+)	`56(+)EA,DB Spring	1			
35	Bat. SPRING (-)	`56(-)EA,DB Spring	1			
36	Bat. SPRING,common		1			
37	TOP CASE COVER	ABS	1			
38	BOTTOM CASE COVER	ABS	1			
39	BATTERY COVER	ABS	1			
40	Key Rubber		1			
41	Key Plate		1			
42	FCC+ETL LABEL STIKER		1			